

# 2SA1029, 2SA1030

Silicon PNP Epitaxial

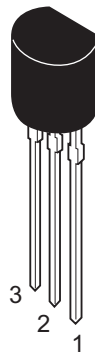
REJ03G0633-0300  
 (Previous ADE-208-1004A)  
 Rev.3.00  
 Aug.10.2005

## Application

- Low frequency amplifier
- Complementary pair with 2SC458 and 2SC2308

## Outline

RENESAS Package code: PRSS0003DA-A  
 (Package name: TO-92 (1))



1. Emitter
2. Collector
3. Base

## Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	2SA1029	2SA1030	Unit
Collector to base voltage	$V_{CBO}$	-30	-55	V
Collector to emitter voltage	$V_{CEO}$	-30	-50	V
Emitter to base voltage	$V_{EBO}$	-5	-5	V
Collector current	$I_C$	-100	-100	mA
Emitter current	$I_E$	100	100	mA
Collector power dissipation	$P_C$	300	300	mW
Junction temperature	$T_j$	150	150	°C
Storage temperature	$T_{stg}$	-55 to +150	-55 to +150	°C

## Electrical Characteristics

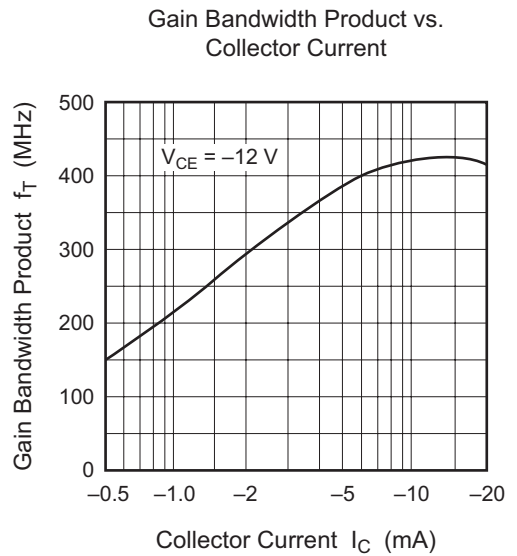
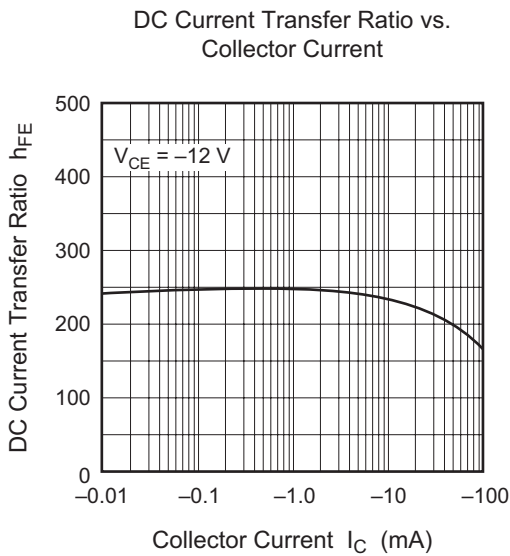
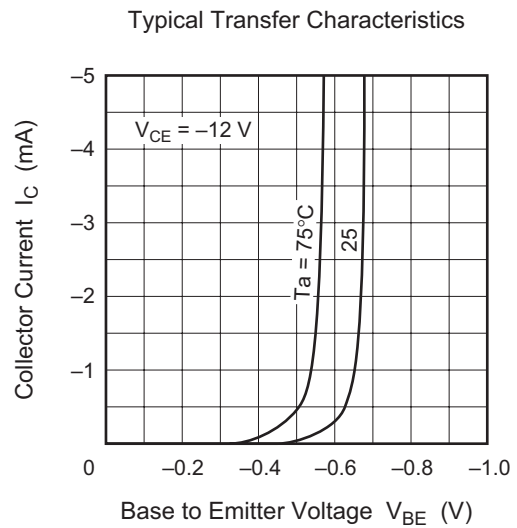
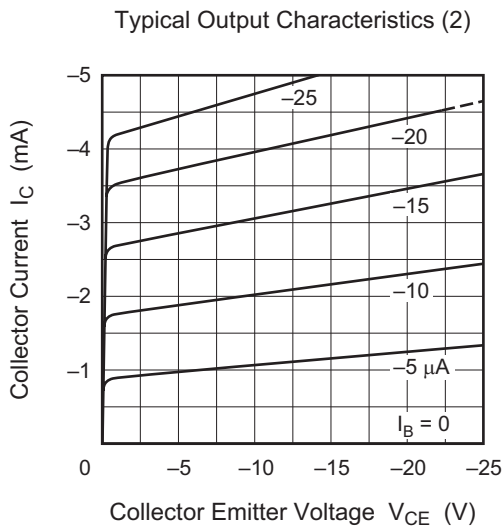
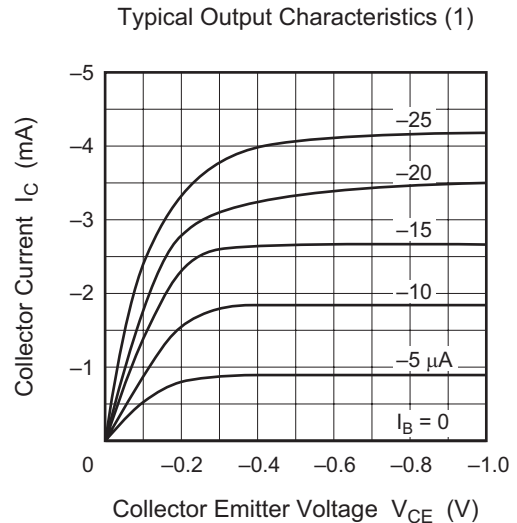
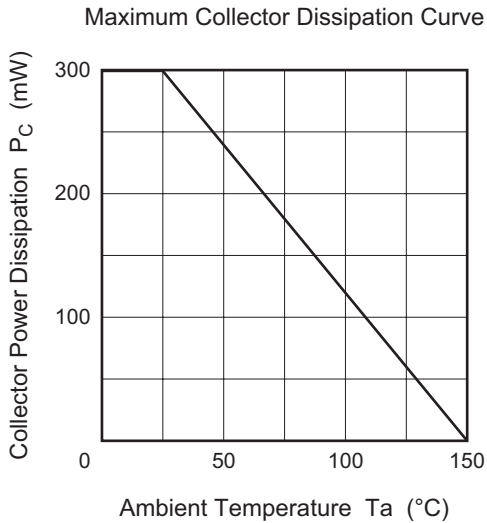
(Ta = 25°C)

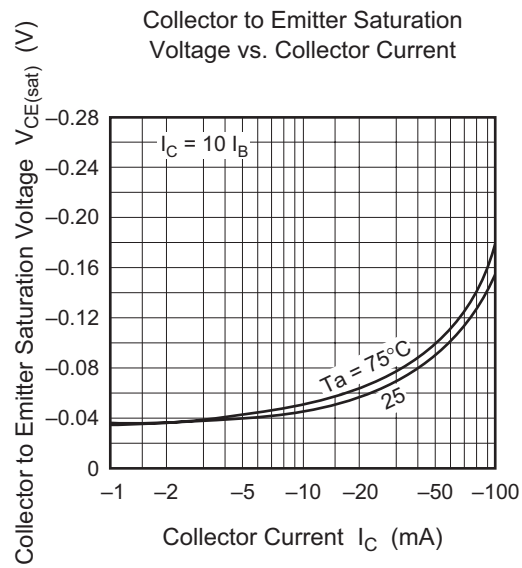
Item	Symbol	2SA1029			2SA1030			Unit	Test conditions
		Min	Typ	Max	Min	Typ	Max		
Collector to base breakdown voltage	$V_{(BR)CBO}$	-30	—	—	-55	—	—	V	$I_C = -10 \mu A, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-30	—	—	-50	—	—	V	$I_C = -1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	-5	—	—	-5	—	—	V	$I_E = -10 \mu A, I_C = 0$
Collector cutoff current	$I_{CBO}$	—	—	-0.5	—	—	-0.5	$\mu A$	$V_{CB} = -18 \text{ V}, I_E = 0$
Emitter cutoff current	$I_{EBO}$	—	—	-0.5	—	—	-0.5	$\mu A$	$V_{EB} = -2 \text{ V}, I_C = 0$
DC current transfer ratio	$h_{FE}^{*1}$	100	—	500	100	—	320		$V_{CE} = -12 \text{ V}, I_C = -2 \text{ mA}$
Base to emitter voltage	$V_{BE}$	—	—	-0.8	—	—	-0.8	V	$V_{CE} = -12 \text{ V}, I_C = -2 \text{ mA}$
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	-0.2	—	—	-0.2	V	$I_C = -10 \text{ mA}, I_B = -1 \text{ mA}$
Gain bandwidth product	$f_T$	200	280	—	200	280	—	MHz	$V_{CB} = -12 \text{ V}, I_C = -2 \text{ mA}$
Collector output capacitance	$C_{ob}$	—	3.3	4.0	—	3.3	4.0	pF	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$

Note: 1. The 2SA1029 and 2SA1030 are grouped by  $h_{FE}$  as follows.

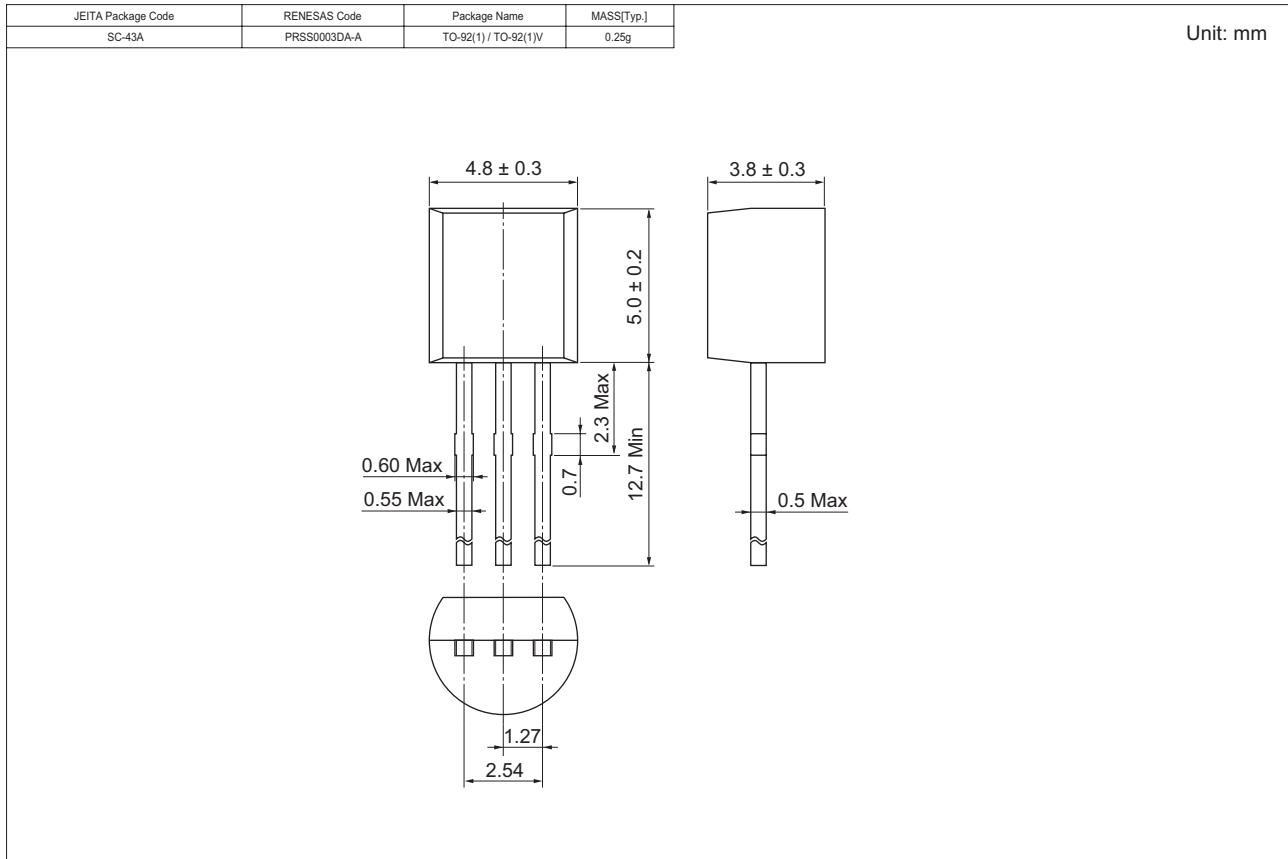
	B	C	D
2SA1029	100 to 200	160 to 320	250 to 500
2SA1030	100 to 200	160 to 320	—

Main Characteristics





### Package Dimensions



### Ordering Information

Part Name	Quantity	Shipping Container
2SA1029BTZ 2SA1029CTZ 2SA1029DTZ 2SA1030BTZ 2SA1030CTZ	2500	Hold Box, Radial Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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#### **Renesas Technology (Shanghai) Co., Ltd.**

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#### **Renesas Technology Malaysia Sdn. Bhd.**

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